



## PATENT ATTORNEY DOCKET NO. 040879-5095

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Stanford W. Crane, Jr. et	al. )
U.S. Application No.: 10/081,146	) Confirmation No.: 8805
Filed: February 25, 2002	) Group Art Unit: 2812
For: MODULAR SEMICONDUCTOR DIE PACKAGE AND METHOD OF MANUFACTURING THEREOF	Examiner: To Be Assigned  ) )

Commissioner for Patents Washington, D.C. 20231

Sir:

## SUBMISSION OF FORMAL DRAWINGS

Submitted herewith are thirty-four (34) sheets of formal patent drawings containing forty (40) figures. It is requested that these drawings be approved and made part of the official record in the above-identified patent application.

If there are any fees due in connection with the filing of these drawings, please charge the fees to our Deposit Account No. 50-0310. If a fee is required for an extension of time under 37 C.F.R. § 1.136 not accounted for above, such an extension is requested, and the fee should also be charged to our Deposit Account.

Respectfully submitted,

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Date: May 20, 2002

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